High Efficiency Boost Converter

General Description

The RT4813C allows systems to take advantage of new battery chemistries that can supply significant energy when the battery voltage is lower than the required voltage for system power ICs. By combining built-in power transistors, synchronous rectification, and low supply current; this IC provides a compact solution for systems using advanced Li-lon battery chemistries.

The RT4813C is a boost regulator designed to provide a minimum output voltage from a single-cell Li-Ion battery, even when the battery voltage is below system minimum. In boost mode, output voltage regulation is guaranteed to a maximum load current of 3.1A. Quiescent current in Shutdown Mode is less than 1μ A, which maximizes battery life.

Ordering Information



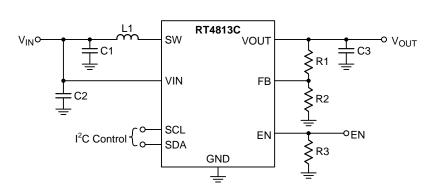
Package Type QUF : UQFN-9L 2x2 (FC) (U-Type) —Lead Plating System G : Green (Halogen Free and Pb Free)

Note :

Richtek products are :

- ► RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- Suitable for use in SnPb or Pb-free soldering processes.

Simplified Application Circuit



Features

- CMCOT Topology and Small Output Ripple when VIN Close VOUT Voltage
- Operates from a Single Li-ion Cell : 1.8V to 5.5V
- Adjustable Output Voltage : 1.8V to 5.5V
- PSM Operation
- Up to 96% Efficiency
- Input Over-Current Limit
- Input / Output Over-Voltage Protection
- Programmable Average Output Current Limit Range : 3100mA to 550mA
- Internal Compensation
- Output Discharge
- Output Short Protection
- True Load Disconnect

Applications

- Single-Cell Li-Ion, LiFePO4 Smart-Phones
- Portable Equipment

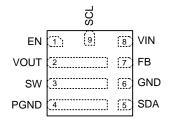
Marking Information

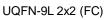


4M : Product Code W : Date Code

Pin Configuration

(TOP VIEW)

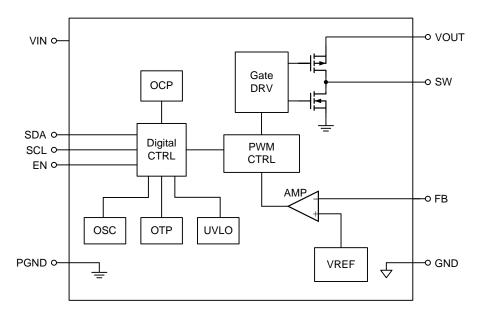




Functional Pin Description

| Pin No. | Pin Name | Pin Function |
|---------|----------|---|
| 1 | EN | Enable input (1 enabled, 0 disabled), must not be left floating. |
| 2 | VOUT | Boost converter output. |
| 3 | SW | Switching node. |
| 4 | PGND | Power ground. |
| 5 | SDA | I ² C interface data input. |
| 6 | GND | Analog ground. |
| 7 | FB | Voltage feedback. |
| 8 | VIN | Power input. Input capacitor CIN must be placed as close to IC as possible. |
| 9 | SCL | I ² C interface clock input. |

Functional Block Diagram



 Copyright © 2017 Richtek Technology Corporation. All rights reserved.
 RICHTEK is a registered trademark of Richtek Technology Corporation.

 www.richtek.com
 DS4813C-00
 September 2017

Operation

The RT4813C combined built-in power transistors, synchronous rectification, and low supply current, it provides a compact solution for system using advanced Li-lon battery chemistries.

In boost mode, output voltage regulation is guaranteed to a maximum load current of 3.1A. Quiescent current in Shutdown mode is less than $1\mu A$, which maximizes battery life.

| М | ode | Depiction | Condition | | | |
|--------|-------|------------------|---|--|--|--|
| | LIN 1 | Linear startup 1 | $V_{IN} > V_{OUT}$ | | | |
| LIN | LIN 2 | Linear startup 2 | Vin > Vout | | | |
| Soft-S | Start | Boost soft-start | Vout < Vout(min) | | | |
| Boost | t | Boost mode | $V_{\text{OUT}} = V_{\text{OUT}(\text{MIN})}$ | | | |

LIN State

When V_{IN} is rising, it enters the LIN State. There are two parts for the LIN state. It provides maximum current for 1A to charge the C_{OUT} in LIN1, and the other one is for 2A in LIN2. By the way, the EN is pulled high and $V_{IN} > UVLO$.

As the Figure 1 shown, if the timeout is over the specification, it will enter the Fault mode.

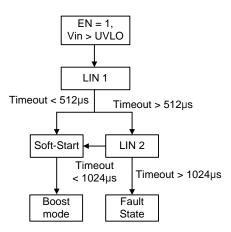


Figure 1. The RT4813C State Chart

Startup and Shutdown State

When V_{IN} is rising and through the LIN state, it will enter the Startup state. If EN is pulled low, any function is turned-off in shutdown mode.

Soft-Start State

It starts to switch in Soft-start state. After the LIN state, output voltage is rising with the internal reference voltage.

Fault State

As the Figure 1 shown, it will enter to the Fault state as below,

• The timeout of LIN2 is over the 1024μ s.

It will be the high impedance between the input and output when the fault is triggered. A restart will be start after 20ms.

OCP

The converter senses the current signal when the high-side P-MOSFET turns on. As a result, the OCP is cycle by-cycle current limitation. If the OCP occurs, the converter holds off the next on pulse until inductor current drops below the OCP limit.

ΟΤΡ

The converter has an over-temperature protection. When the junction temperature is higher than the thermal shutdown rising threshold, the system will be latched and the output voltage will no longer be regulated until the junction temperature drops under the falling threshold.

Absolute Maximum Ratings (Note 1) • VIN, FB, EN, SW, SDA, SCL to GND -0.2V to 6V • VOUT to GND 6V • Power Dissipation, P_D @ T_A = 25°C 0.89W • Package Thermal Resistance (Note 2) 0.89W • UQFN-9L 2x2 (FC), θ_{JA} 111.5°C/W UQFN-9L 2x2 (FC), θ_{JA} 19.6 °C/W • Lead Temperature (Soldering, 10 sec.) 260°C • Junction Temperature Range -65°C to 150°C • Storage Temperature Range -65°C to 150°C • BM (Human Body Model) 2kV

Recommended Operating Conditions (Note 4)

| Input Voltage Range | 1.8V to 5.5V |
|----------------------------|----------------|
| Output Voltage Range | 1.8V to 5.5V |
| Ambient Temperature Range | –40°C to 85°C |
| Junction Temperature Range | –40°C to 125°C |

Electrical Characteristics

| Parameter | Symbol | Test Conditions | Min | Тур | Max | Unit |
|--|----------------------|---|-------|-----|-------|------|
| Under-Voltage Lockout Rising Threshold | VUVLOR | | 1.6 | 1.7 | 1.8 | V |
| Under-Voltage Lockout Falling Threshold | VUVLOF | | 1.5 | 1.6 | 1.7 | V |
| FB Voltage | VFB | ССМ | 0.495 | 0.5 | 0.505 | V |
| VOUT Voltage (I ² C) | Vout | ССМ | -1 | 0 | 1 | % |
| Shutdown Current | I _{SHDN} | EN = 0V, | | 0.1 | 2 | μΑ |
| Quiescent Current | | Close loop, no load | | 120 | | μA |
| Pre-Charge Current | I _{Pre} | | | 1 | | А |
| Output Current | I _{O, 1.2A} | ILIM_AVG<3:0> : 1011 for I _{OUT} = 1.16A | 0.95 | | 1.25 | A |
| | IO, 1.5A | ILIM_AVG<3:0> : 1001 for I _{OUT} = 1.5A | 1.32 | | 1.7 | |
| Switching Frequency | f _{SW} | $V_{OUT} - V_{IN} > 1V, CCM$ | | 0.5 | | MHz |
| Valley Current Limit | loc | | | 6 | | А |
| High-Side Switch RON | | V _{IN} = 5V | | 43 | 55 | mΩ |
| Low-Side Switch RON | | V _{IN} = 5V | | 26 | 35 | mΩ |
| FB Pin Input Leakage | I _{FB} | | -1 | | 1 | μA |

 $(V_{IN} = 3.6V, T_A = 25^{\circ}C, unless otherwise specified)$

RT4813C

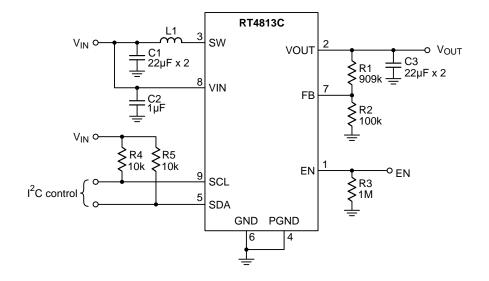
| Parameter | | Symbol | Test Conditions | Min | Тур | Max | Unit |
|---------------------------|-----------------------------------|------------------------|---|-----|-----|-----|------|
| Leakage of S | SW | Isw | | | | 5 | μA |
| Line Regulat | tion | $\Delta VOUT$, LINE | CCM, V _{IN} = 2.7V to 4.5V, V _{OUT} = 5V, I _{OUT} = 500mA | | 0.5 | | % |
| Load Regulation | | $\Delta V_{OUT, LOAD}$ | CCM, $I_{OUT} < 3.1A$, $V_{IN} = 3.6V$, $V_{OUT} = 5V$ | | 0.5 | | % |
| Output Over Protection | Output Over-Voltage Protection | | | | 6 | | V |
| EN Input | Low-Level | VIL | | | | 0.4 | V |
| Voltage | High-Level | VIH | | 1.2 | | | V |
| EN Sink Cur | EN Sink Current | | | | 0.1 | 1 | μA |
| Thermal Shutdown | | T _{SD} | | | 160 | | °C |
| Thermal Shu Hysteresis | utdown | ΔT _{SD} | | | 30 | | °C |

Note 1. Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

- Note 2. θ_{JA} is measured under natural convection (still air) at $T_A = 25^{\circ}C$ with the component mounted on a high effective-thermal-conductivity four-layer test board on a JEDEC 51-7 thermal measurement standard. θ_{JC} is measured at the exposed pad of the package.
- Note 3. Devices are ESD sensitive. Handling precaution recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.



Typical Application Circuit

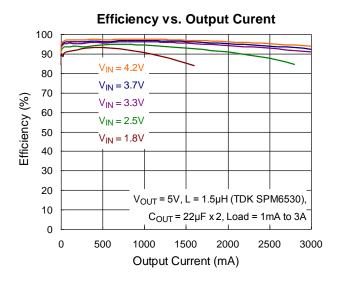


 Copyright © 2017 Richtek Technology Corporation. All rights reserved.
 RICHTEK is a registered trademark of Richtek Technology Corporation.

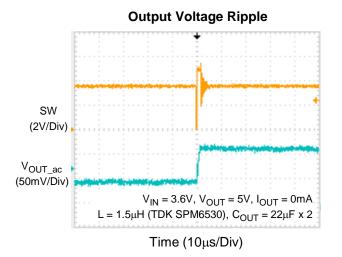
 www.richtek.com
 DS4813C-00
 September 2017

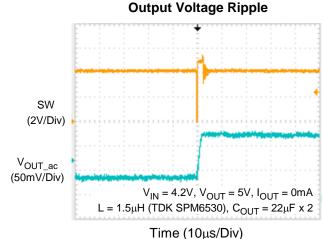
RT4813C

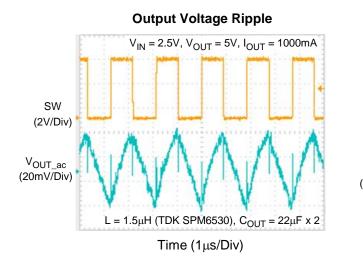
Typical Operating Characteristics



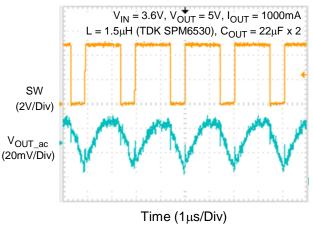
Output Voltage Ripple SW (2V/Div) V_{OUT_ac} (50mV/Div) $V_{IN} = 2.5V, V_{OUT} = 5V, I_{OUT} = 0mA$ L = 1.5µH (TDK SPM6530), C_{OUT} = 22µF x 2 Time (10µs/Div)



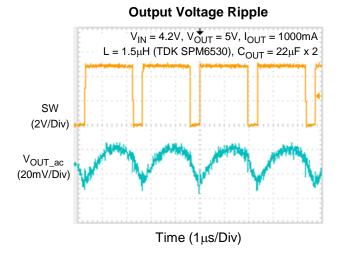




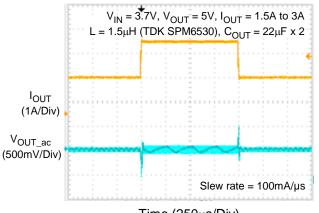
Output Voltage Ripple



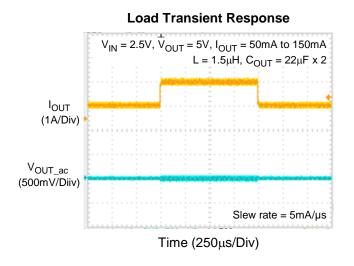




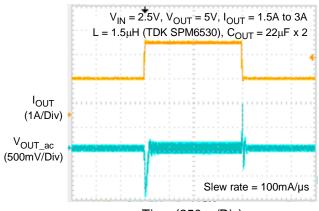
Load Transient Response



Time (250µs/Div)

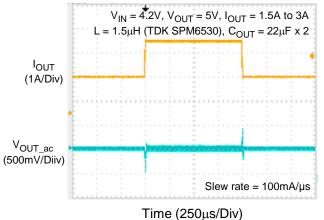


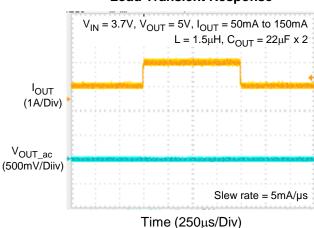




Time (250µs/Div)





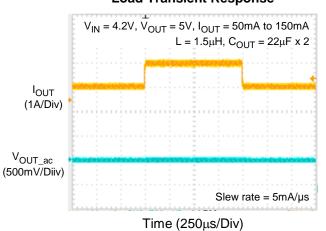


Load Transient Response

 Copyright © 2017 Richtek Technology Corporation. All rights reserved.
 RICHTEK is a registered trademark of Richtek Technology Corporation.

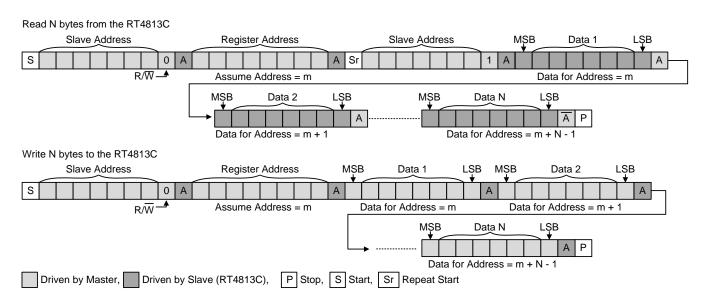
 www.richtek.com
 DS4813C-00
 September
 2017



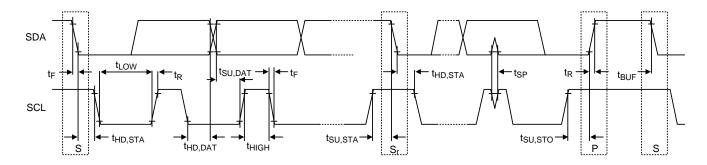


I²C Interface

The RT4813C I²C slave address = 0111001 (7 bits). I²C interface supports fast mode (bit rate up to 400kb/s). The write or read bit stream (N \ge 1) is shown below :



I²C Waveform Information





I²C Register

| Function | unction Register Address | | b[7] (MSB) | b[6] | b[5] | b[4] | b[3] | b[2] | b[1] | b[0] (LSB) |
|--------------|--------------------------|------------|---------------|--|-------------|---------|------|----------|------|---------------|
| | | Meaning | Reversed | ILIM_OFF | IPC | HG | DF | RV_SEL<2 | 2:0> | SSFM |
| Config | 0X01 | Default | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 0 |
| | | Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | ILIM_OFF | | | ley current li current limit current limit | enable (de | | | | | |
| | IPCHG | | | je current se lefault) | etting. | | | | | |
| DRV_SEL<2:0> | | | 000 : Slov | driving capa vest : : test (default | - | | | | | |
| SSFM | | | 0 : Sprea | bectrum sett d spectrum o d spectrum o | disable (de | efault) | | | | |

| Function | n Register Address | | b[7] (MSB) | b[6] | b[5] | b[4] | b[3] | b[2] | b[1] | b[0] (LSB) |
|----------------------|--------------------|------------|---------------|--|--------|---------|-----------|--------------|------------|---------------|
| | | Meaning | | ILIM_SS | 6<7:4> | | | ILIM_A | 4VG<3:0> | |
| Charger Control 3 | 0X03 | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Control o | | Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | | | | period boos rent limit set | | • | g. The de | efault curre | ent and so | oft-start min |
| | | .7.4. | Code | Current | Code | Current | Code | Current | Code | Current |
| | ILIM_SS<7:4> | | 1001 | 3000mA (default) | 1011 | 4000mA | 1101 | 5000mA | 1111 | 6000mA |
| | | | 1010 | 3500mA | 1100 | 4500mA | 1110 | 5500mA | | |
| | | | Average | Average Output Current limit setting. The default current is 3100mA. | | | | | | |
| | | | Code | Current | Code | Current | Code | Current | Code | Current |
| ILII | ILIM AVG<3:0> | | 0000 | 3030mA (Default) | 0100 | 2350mA | 1000 | 1670mA | 1100 | 990mA |
| | | 0001 | 2860mA | 0101 | 2180mA | 1001 | 1500mA | 1101 | 820mA | |
| | | | 0010 | 2690mA | 0110 | 2010mA | 1010 | 1330mA | 1110 | 650mA |
| | | | 0011 | 2520mA | 0111 | 1840mA | 1011 | 1160mA | 1111 | 480mA |



| Function | n Register Address | | b[7] (MSB) | b[6] | b[5] | b[4] | b[3] b[2] | | b[1] | b[0] (LSB) |
|--|--------------------|------------|---------------|--|----------|----------|-----------|-----|---------------|------------------|
| OPTION 0X04 | | Meaning | Reversed | Reversed | Reversed | Reversed | F | SW | EN _IAVGCL | EN _Discharge |
| | Default | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | |
| | | Read/Write | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | FSW | | | quency setti z ot allowed z Hz (default) | | | | | | |
| E | EN_IAVGCL 0 : | | | Enable average output current limit 0 : Disable 1 : Enable (default) | | | | | | |
| Enable dis EN_Discharge 0 : Disable 1 : Enable | | | e | | | | | | | |

Copyright © 2017 Richtek Technology Corporation. All rights reserved. www.richtek.com

Enable

The device can be enabled or disabled by the EN pin. When the EN pin is higher than the threshold of logic-high, the device starts operating with soft-start. Once the EN pin is set at low, the device will be shut down. In shutdown mode, the converter stops switching, internal control circuitry is turned off, and the load is disconnected from the input. This also means that the output voltage can drop below the input voltage during shutdown.

Soft-Start State

After the successful completion of the LIN state (VOUT \geq V_{IN} – 300mV), the regulator begins switching with boost valley-current limited value 3000mA.

During Soft-Start state, VOUT is ramped up by Boost internal loop. If VOUT fails to reach target value during the Soft-Start period for more than 2ms, a fault condition is declared.

Output Voltage Setting

The output voltage is adjustable by an external resistive divider. The resistive divider must be connected between VOUT, FB and GND. When the output voltage is regulated properly, the typical value of the voltage at the FB pin is 500mV. Output voltage can be calculated by equation as below :

$$R1 = R2 \times \left(\frac{V_{OUT}}{V_{FB}} - 1\right)$$

Power Save Mode

PSM is the way to improve efficiency at light load.

When the output voltage is lower than a set threshold voltage, the converter will operate in PSM.

It raises the output voltage with several pulses until the loop exits PSM.

Under-Voltage Lockout

The under-voltage lockout circuit prevents the device from operating incorrectly at low input voltages. It prevents the converter from turning on the power switches under undefined conditions and prevents the battery from deep discharge. VIN voltage must be greater than 1.65V to enable the converter. During operation, if VIN voltage drops below 1.55V, the converter is disabled until the supply exceeds the UVLO rising threshold. The RT4813C automatically restarts if the input voltage recovers to the input voltage UVLO high level.

Thermal Shutdown

The device has a built-in temperature sensor which monitors the internal junction temperature. If the temperature exceeds the threshold, the device stops operating. As soon as the IC temperature has decreased below the threshold with a hysteresis, it starts operating again. The built-in hysteresis is designed to avoid unstable operation at IC temperatures near the over temperature threshold.

Inductor Selection

The recommended nominal inductance value is 1.5uH

It is recommended to use inductor with dc saturation current ≥ 6000mA

| Manufacturer | Series | Dimensions (in mm) | Saturation Current (mA) |
|--------------|----------|--------------------|-------------------------|
| TDK | SPM6530T | 7.1 x 6.5 x 3.0 | 11500 |
| Taiyo Yuden | NRS5040T | 5.15 x 5.15 x 4.2 | 6400 |

Table 1. List of Inductors

Input Capacitor Selection

At least two capacitor and capacitance is 22μ F with rating voltage is 16V for DC bias input capacitor is recommended to improve transient behavior of the regulator and EMI behavior of the total power supply circuit for SW. And at least a 1μ F ceramic capacitor placed as close as possible to the VIN and GND pins of the IC is recommended.

Output Capacitor Selection

At least 22 μ F x 2 capacitors is recommended to improve V_{OUT} ripple.

Output voltage ripple is inversely proportional to $C_{\mbox{OUT}}.$

Output capacitor is selected according to output ripple which is calculated as :

$$V_{RIPPLE(P-P)} = t_{ON} \times \frac{l_{LOAD}}{C_{OUT}}$$
 and

$$t_{ON} = t_{SW} \times D = t_{SW} \times \left(1 - \frac{V_{IN}}{V_{OUT}}\right)$$

therefore :

$$\begin{split} C_{OUT} = t_{SW} \times & \left(1 - \frac{V_{IN}}{V_{OUT}}\right) \times \frac{I_{LOAD}}{V_{RIPPLE(P-P)}} \\ \text{and} \end{split}$$

 $t_{SW} = \frac{1}{f_{SW}}$

The maximum V_{RIPPLE} occurs at minimum input voltage and maximum output load.

Output Discharge Function

With the EN pin set to low, the VOUT pin is internally connected to GND for 10ms by an internal discharge N-MOSFET switch. After the 10ms, IC will be true-shut down.

This feature prevents residual charge voltages on capacitor connected to VOUT pins, which may impact proper power up of the system.

Valley Current Limit

The RT4813C employs a valley-current limit detection scheme to sense inductor current during the off-time. When the loading current is increased such that the loading is above the valley current limit threshold, the off-time is increased until the current is decreased to valley-current threshold. Next on-time begins after current is decreased to valley-current threshold. On-time is decided by $(V_{OUT} - V_{IN}) / V_{OUT}$ ratio. The output voltage decreases when further loading current increase. The current limit function is implemented by the scheme, refer to Figure 2.

Average Output Current Limit

The RT4813C features the average output current limit to protect the output terminal. When the load current is over the limit, output current will be clamped.

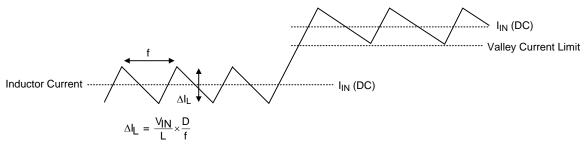


Figure 2. Inductor Currents In Current Limit Operation

RT4813C

Thermal Considerations

The junction temperature should never exceed the absolute maximum junction temperature $T_{J(MAX)}$, listed under Absolute Maximum Ratings, to avoid permanent damage to the device. The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the difference between the junction and ambient temperatures. The maximum power dissipation can be calculated using the following formula :

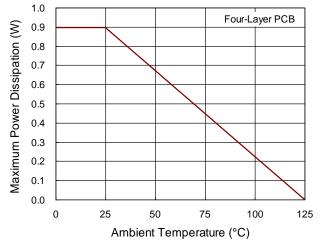
$\mathsf{P}_{\mathsf{D}(\mathsf{MAX})} = (\mathsf{T}_{\mathsf{J}(\mathsf{MAX})} - \mathsf{T}_{\mathsf{A}}) / \theta_{\mathsf{J}\mathsf{A}}$

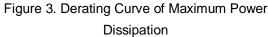
where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction-to-ambient thermal resistance.

For continuous operation, the maximum operating junction temperature indicated under Recommended 125°C. Operating Conditions is The junction-to-ambient thermal resistance, θ_{JA} , is highly package dependent. For a UQFN-9L 2x2 (FC) package, the thermal resistance, θ_{JA} , is 111.5°C/W on a standard JEDEC 51-7 high effective-thermal-conductivity four-layer test board. The maximum power dissipation at $T_A = 25^{\circ}C$ can be calculated as below :

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (111.5^{\circ}C/W) = 0.89W$ for a UQFN-9L 2x2 (FC) package.

The maximum power dissipation depends on the operating ambient temperature for the fixed $T_{J(MAX)}$ and the thermal resistance, θ_{JA} . The derating curves in Figure 3 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.





Layout Consideration

The PCB layout is an important step to maintain the high performance of the RT4813C.

Both the high current and the fast switching nodes demand full attention to the PCB layout to save the robustness of the RT4813C through the PCB layout. Improper layout might show the symptoms of poor line or load regulation, ground and output voltage shifts, stability issues, unsatisfying EMI behavior or worsened efficiency. For the best performance of the RT4813C, the following PCB layout guidelines must be strictly followed.

- Input/Output capacitors must be placed as close as possible to the Input/Output pins.
- SW should be connected to Inductor by wide and short trace, keep sensitive components away from this trace.
- The feedback divider should be placed as close as possible to the FB pin.



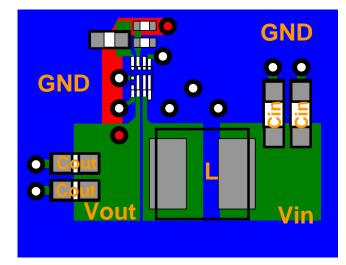
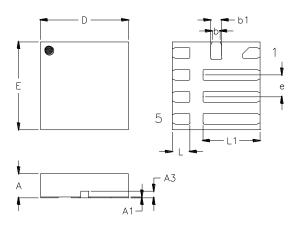


Figure 4. PCB Layout Guide

Copyright © 2017 Richtek Technology Corporation. All rights reserved. RICHTEK is a registered trademark of Richtek Technology Corporation. www.richtek.com



Outline Dimension

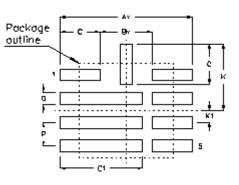


| Symbol | Dimensions | In Millimeters | Dimension | s In Inches |
|--------|------------|----------------|-----------|-------------|
| Symbol | Min | Max | Min | Max |
| A | 0.500 | 0.600 | 0.020 | 0.024 |
| A1 | 0.000 | 0.050 | 0.000 | 0.002 |
| A3 | 0.100 | 0.175 | 0.004 | 0.007 |
| b | 0.130 | 0.230 | 0.005 | 0.009 |
| b1 | 0.200 | 0.300 | 0.008 | 0.012 |
| D | 1.950 | 2.050 | 0.077 | 0.081 |
| E | 1.950 | 2.050 | 0.077 | 0.081 |
| е | 0.5 | 500 | 0.0 |)20 |
| L | 0.350 | 0.450 | 0.014 | 0.018 |
| L1 | 1.250 | 1.350 | 0.049 | 0.053 |

U-Type 9L QFN 2x2 (FC) Package



Footprint Information



| Package | Number | | Footprint Dimension (mm) | | | | | | | Toloropoo |
|---------------|--------|------|--------------------------|------|------|------|------|------|------|-----------|
| | of Pin | Р | Ax | Bx | C*6 | C1*3 | D*9 | K | K1 | Tolerance |
| UQFN2*2-9(FC) | 9 | 0.50 | 2.80 | 1.10 | 0.85 | 1.75 | 0.25 | 1.40 | 0.25 | ±0.05 |

Richtek Technology Corporation

14F, No. 8, Tai Yuen 1st Street, Chupei City Hsinchu, Taiwan, R.O.C. Tel: (8863)5526789

Richtek products are sold by description only. Richtek reserves the right to change the circuitry and/or specifications without notice at any time. Customers should obtain the latest relevant information and data sheets before placing orders and should verify that such information is current and complete. Richtek cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Richtek product. Information furnished by Richtek is believed to be accurate and reliable. However, no responsibility is assumed by Richtek or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Richtek or its subsidiaries.

Copyright © 2017 Richtek Technology Corporation. All rights reserved. RICHTEK is a registered trademark of Richtek Technology Corporation.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for richtek manufacturer:

Other Similar products are found below :

RT2101AGQW RT6212BHGJ6F EVB_RT5047GSP EVB_RT7275GQW EVB_RT7297CHZSP RT5795AGQW RT9742CNGJ5 RT9080N-08GJ5 RT8296AHZSP EVB_RT5047AGSP EVB_RT7243GQW EVB_RT7272BGSP RT8097AHGE EVB_RT7247CHGSP EVB_RT7276GQW EVB_RT8293AHZSP EVB_RT6200GE RT7238DGQUF EVB_RT7235GQW EVB_RT8292AHZSP EVB_RT7237AHGSP EVB_RT7251AZQW RT5047AGSP RT7240GSP EVB_RT7272AGSP RT8812AGQW EVB_RT7237CHGSP EVB_RT7247AHGSP EVB_RT7252BZSP EVB_RT7280GQW EVB_RT8297BZQW EVB_RT7231GQW EVB_RT7232GQW EVB_RT7236GQW EVB_RT7250BZSP EVB_RT7251BZQW EVB_RT7279GQW EVB_RT8008GB RT7240GSP(Z10) RT9059GSP(Z00) RT9167A-18GB RT6154BGQW RT5711AHGQW RT9081AGQZA(2) RT8008GB RT9728BLGQW RT9193-15GU5 RT5788AGJ8F RT6278BHGQUF RT9026GFP